

Hybrid (analog and digital) Silicon Tuner for terrestrial and cable TV reception

Rev. 2 — 15 December 2010

Preliminary data sheet

1. General description

The TDA18273HN is a high performance Silicon Tuner designed for terrestrial and cable TV reception for both analog and digital signals.

The TDA18273HN supports all analog and digital TV standards and delivers a LOW IF (LIF) signal to a demodulator for analog TV and/or a channel demodulator for digital TV.

2. Features and benefits

- Fully integrated IF selectivity; eliminating the need for external SAW filters
- Worldwide multistandard terrestrial and cable
- Fully integrated oscillators
- Alignment free
- Single 3.3 V supply voltage
- Power level detector
- Integrated wideband gain control
- Crystal oscillator output buffer (16 MHz) for single crystal applications
- I²C-bus interface compatible with 3.3 V microcontrollers
- Self AGC synchronization mode (VSYNC)
- Very fast tuning time
- LIF channel center frequency output ranging from 3 MHz to 5 MHz
- 1.7 MHz, 6 MHz, 7 MHz, 8 MHz and 10 MHz channel bandwidths
- Ready for DVB-T2 and DVB-C2
- RoHS compliant
- Strong immunity to spurious and field interferences



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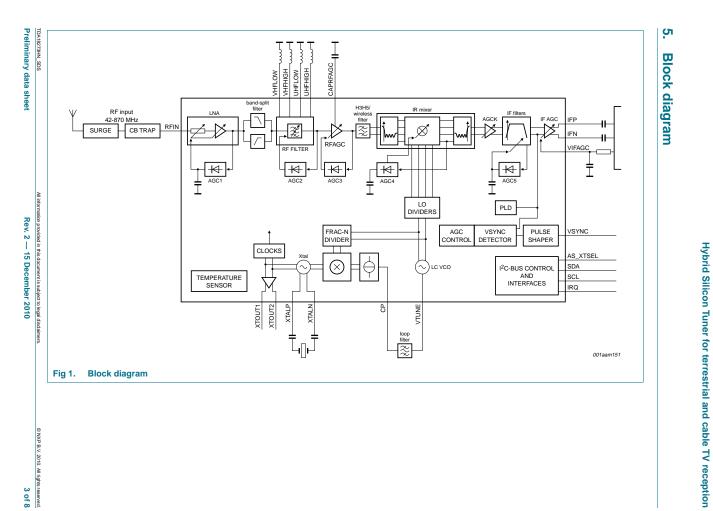
3. Quick reference data

| Table 1. | Quick reference data | | | | | | |
|--------------------|-----------------------------------|--|------------|-----|-----|-----|--------|
| Symbol | Parameter | Conditions | | Min | Тур | Max | Unit |
| f _{RF} | RF frequency | full range of RF input | | 42 | - | 870 | MHz |
| NF _{tun} | tuner noise figure | 75 Ω source; maximum gain | | - | 4.0 | 4.6 | dB |
| Φjit | phase jitter | UHF; integrated from 250 Hz to 4 MHz | | - | 0.4 | 0.6 | degree |
| CSO | composite second-order distortion | worst interferer over RF frequency with respect to wanted carrier | <u>[1]</u> | - | -60 | -55 | dBc |
| СТВ | composite triple beat | worst interferer over RF frequency with respect to wanted carrier for frequency ≤ 550 MHz | | - | -65 | -60 | dBc |
| | | worst interferer over RF frequency with respect to wanted carrier for frequency > 550 MHz | | - | - | -55 | dBc |
| ICP _{1dB} | 1 dB input compression point | at tuner input and minimum gain | | 122 | - | - | dBμV |

[1] Channel loading assumptions: 129 channels at 75 dB $\!\mu V$ each.

4. Ordering information

| Table 2. Ordering | informatio | n | |
|-------------------|------------|--|----------|
| Type number | Package | | |
| | Name | Description | Version |
| TDA18273HN/C1 | HVQFN40 | plastic thermal enhanced very thin quad flat package; no leads; 40 terminals; body $6 \times 6 \times 0.85$ mm | SOT618-1 |



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6. Limiting values

Table 3. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|------------------|---------------------------------|---------------------------------------|------|-----------------------|------|
| V _{CC} | supply voltage | | -0.3 | +3.6 | V |
| VI | input voltage | V _{CC} < 3.3 V | -0.3 | V _{CC} + 0.3 | V |
| | | V _{CC} > 3.3 V | -0.3 | +3.6 | V |
| T _{stg} | storage temperature | | -40 | +150 | °C |
| Tj | junction temperature | | - | 125 | °C |
| T _{amb} | ambient temperature | | -20 | <u>[1]</u> | °C |
| V _{ESD} | electrostatic discharge voltage | EIA/JESD22-A114 (HBM) | -2 | +2 | kV |
| | | EIA/JESD22-C101-C (FCDM) class III[2] | 750 | - | V |
| | | | | | |

[1] The maximum allowed ambient temperature $T_{amb(max)}$ depends on the assembly conditions of the package and especially on the design of the Printed-Circuit Board (PCB) and die connection. The application mounting must be done in such a way that the maximum junction temperature is never exceeded. The junction temperature: $T_j = T_{amb} + \Delta T_{j-c}$ where $\Delta T_{j-c} = power \times R_{th}$.

[2] Class III: 500 V to 1000 V.

7. Abbreviations

| cronym | Description | |
|----------------|--|--|
| GC | Automatic Gain Control | |
| GCK | Automatic Gain Control step Killer | |
| В | Citizen Band | |
| VB | Digital Video Broadcasting | |
| VB-T/T2/C/C2/H | DVB-Terrestrial/Terrestrial second generation/Cable/Handheld | |
| CDM | Field-induced Charged-Device Model | |
| RAC-N | Fractional-N | |
| BM | Human Body Model | |
| | Intermediate Frequency | |
| 1 | Image Rejection | |
| 1A | Low-Noise Amplifier | |
| C | Local Oscillator | |
| СВ | Printed Circuit Board | |
| D | Power Level Detector | |
| F | Radio Frequency | |
| oHS | Restriction of Hazardous Substances | |
| ٩W | Surface Acoustic Wave | |
| HF | Ultra High Frequency | |
| ΗF | Very High Frequency | |
| SYNC | Vertical SYNChronization | |
| al | Crystal | |

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8. Revision history

| Table 5. Revision histo | ory | | | |
|-------------------------|--------------|------------------------|---------------|------------|
| Document ID | Release date | Data sheet status | Change notice | Supersedes |
| TDA18273HN_SDS v.2[1] | 20101215 | Preliminary data sheet | - | - |

[1] SDS revision 1 is not available.

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9. Legal information

9.1 Data sheet status

| Document status[1][2] | Product status ^[3] | Definition |
|--------------------------------|-------------------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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